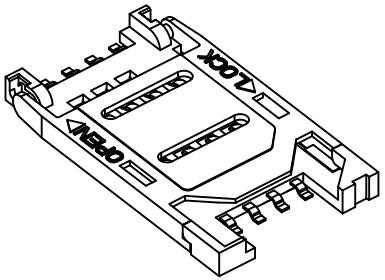

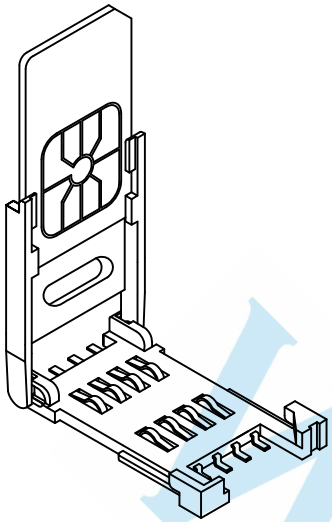

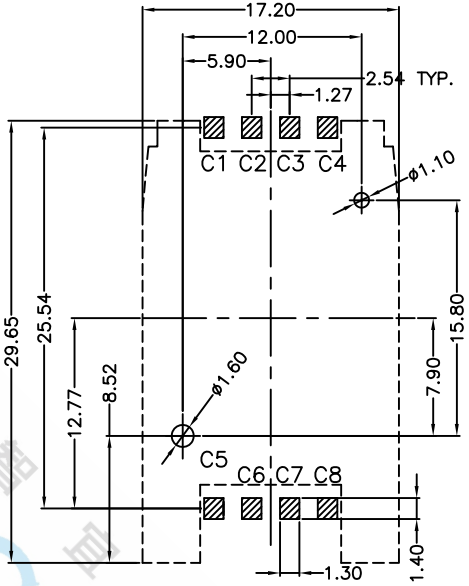

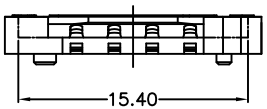

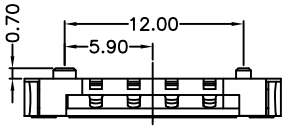

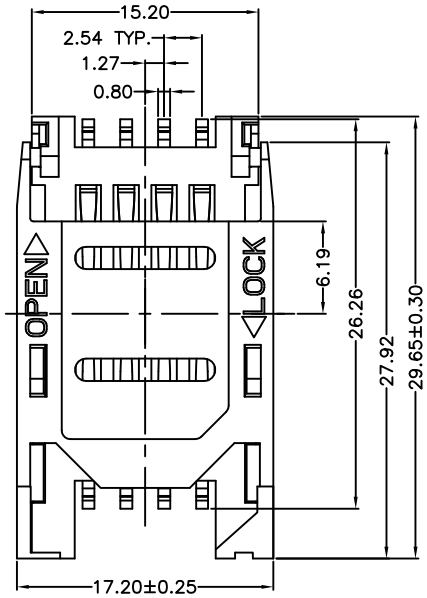

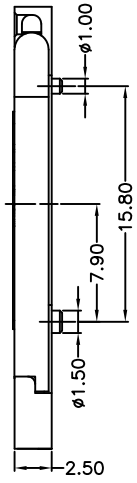

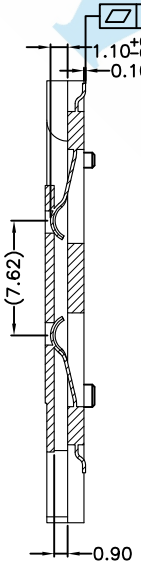

PIN NO.	NAME
C1	Vcc
C2	RST
C3	CLK
C4	RFU
C5	GND
C6	Vpp
C7	I/O
C8	RFU

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0), BLACK
TERMINAL: PHOSPHOR BRONZE, GOLD PLATED ON CONTACT AREA TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
CONTACT RESISTANCE: 30m OHMS MAX
INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
OPERATION TEMPERATURE: -25°C~+85°C

DIMENSIONS TOLERANCE METRIC											
Up to 5	±0.2	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審校(CH'K)	Calvin	圖名(NAME) SIM CARD 8PIN PCB MOUNT SMT HINGE TYPE WITH POST		WISCONN Technology Co.,Ltd	
Above 5~15	±0.3	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena	料號(PART NUMBER)	WSIM-08FHTBSR-C	Tel:02-2790-1979 Fax:02-2790-1569	
Above 15~30	±0.4	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期(DATE)	JUN.24.2016	圖號(DRAW NUMBER)	T004	比例(SCALE) 1/1	圖紙(SIZE) A4 頁次(SHEET) 1 版次(REV.) A
Above 30~50	±0.5							圖檔(FILE NAME .DWG)			
Angle	±0.3°										

WISCONN TECHNOLOGY